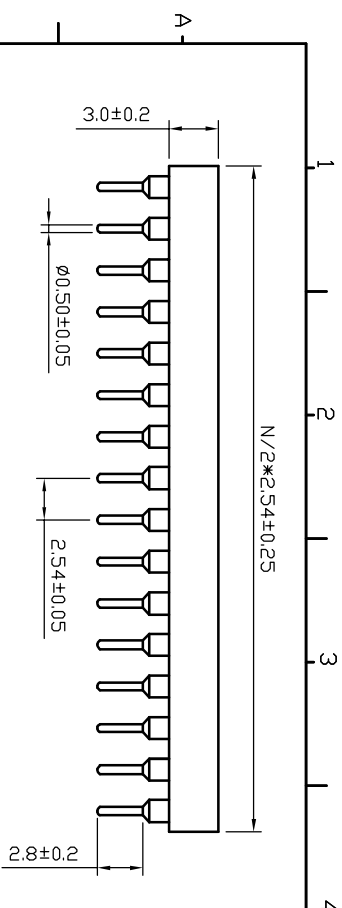


	三型	四型	六型	九型
A	7.62	10.16	15.24	22.86
B	4.14	6.68	11.76	19.38
C	10.12	12.66	17.74	25.36

ELECTRICAL:
CURRENT RATING: 3.0Amps/CONTACT MAX.
CONTACT RESISTANCE: 20mΩ/CONTACT MAX.
INSULATION RESISTANCE: 1000MΩ AT V=100V MIN.
OPERATING VOLTAGE: 60V AC/DC
MECHANICAL
AVERAGE INSERTION FORCE WITH STEEL PIN OF Ø0.43mm: 250g MAX.
AVERAGE WITH DRAWAL FORCE WITH STEEL PIN OF Ø0.43mm: 25g MIN.
MECHANICAL LIFE CYCLE: 200 CYCLE MIN.
OPERATING TEMPERATURES: GOLD PLATED: -55°C TD +125°C
TIN PLATED: -40°C TD +105°C
SOLDERING TEMPERATURE: PBT: +240°C, 10S MAX.

MATERIAL
PIN: BRASS, MACHINED
CLIP: BERYLLIUM COPPER OR PHOSPHOR BRONZE
INSULATOR BODY(BLACK): PBT OR OTHER(UL94V-0)

PART NO.

Z-100 *****0*



0=NEXTRON LOGO
1=NO LOGO

NO. OF CONTACT

06~64=06PIN~64PIN

PLATED

DIP SPACING

3=7.62mm
4=10.16mm
6=15.24mm
9=22.86mm

HOUSING TYPE

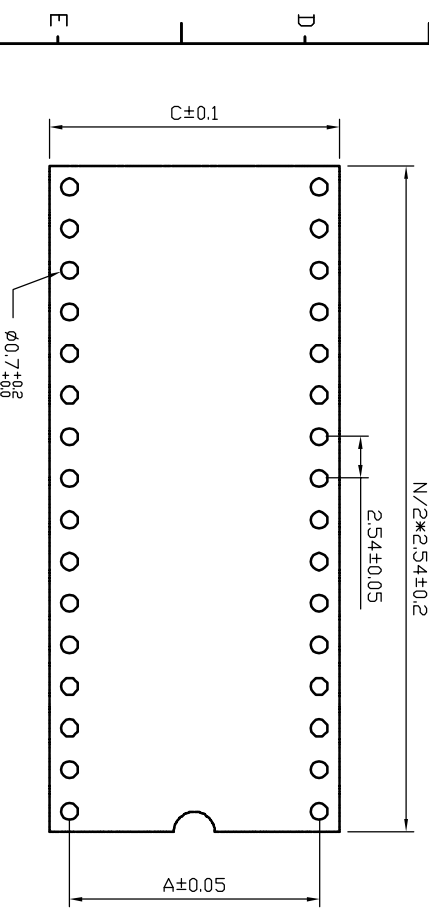
1=WITH BAR
2=WITHOUT BAR (FOR 6~16PIN ONLY)

PITCH

0=2.54mm

CODE	PIN PLATED	CLIP PLATED
1001	TIN 200μ"	GOLD FLASH
1003	TIN 200μ"	GOLD 10μ"
1005	TIN 200μ"	GOLD 30μ"
1007	TIN 200μ"	TIN 200μ"
1301	GOLD FLASH	GOLD FLASH
1303	GOLD FLASH	GOLD 10μ"
1305	GOLD FLASH	GOLD 30μ"
1307	GOLD FLASH	TIN 200μ"

PCB LAYOUT



NEXTRON
NEXTRONICS ENGINEERING CORP.
TITLE: CUSTOMER DWG

UNITS	mm	INCH
GENERAL TOLERANCES: (UNLESS SPECIFIED)		
4 PLACE ±.*** ±.***		
3 PLACE ±.*** ±.***		
2 PLACE ±.010 ±.***		
1 PLACE ±.030 ±.***		
ANGULAR: X° ± 1°		
NAME: 2.54mm IC SOCKET		
OPEN FRAME SOLDER TYPE		
PART NO: Z-100*****0*		
APPD: 楊海文 2016/3/17		
CHKD: 廖小瓊 2016/3/17		
DRAWN: 陳惠枝 2016/3/17		
DWG NO: 010-0000-633		
SCALE: 1/1		
SHEET: 1/1		
REV: C		

A2

D-PRD-034